

XL-2020RGBC-SK6812B

技术数据表

Technical Data Sheet

2020 幻彩 贴片式发光二极管

特点 (Characteristics):

* 外观尺寸 (L/W/H) :2.0*2.0*0.65mm outline Dimensions (L/w/h): 2.0*2.0*0.65mm

* 发光颜色及胶体: 七彩幻彩/雾状胶体

Luminous color and colloid: Colorful magic/ mist colloid

* 环保工艺符合 ROHS 要求

Environmental protection products Complied With ROHS Directive

* 湿气敏感性等级 (MSL):4-5a 级

Moisture sensitivity level (MSL) : 4-5a levels

* EIA 规范标准包装

EIA standard packaging

* 适用于 SMT 贴片自动化生产

Suitable for SMT automatic production

* 适用于红外线回流焊制程

应用领域(Product application):

* LED 全彩发光字灯串

Led full-color luminous word lamp string,

* LED 全彩模组

led full-color module

* LED 幻彩软硬灯条, LED 护栏管

Led magic color soft and hard light strip, LED guardrail tube

* LED 外观, 情景照明

Led appearance, scene lighting

* LED 异性屏

Led heterosexual screen

* 各种电子产品, 电器设备跑马灯

All kinds of electronic products, electrical equipment, runninglights













SK6812B 是一个集控制电路与发光电路于一体的智能外控 LED 光源。其外型 与一个 2020 LED 灯珠相 同,每个元件即为一个像素点。像素点内部包含了智 能数 字接口数据锁存信号整形放大驱动电路,电源稳 高精度 RC 振荡器,输出驱动采用专利 PWM 技术,有效保证了像素点内光的 颜 压电路,内置恒流电路, 色高一致性。芯片采用单线通讯方式, 采用归零码的方式发送信号。芯片在上电复位以后,接受 DIN 端打来的数 据,接受够 24 bit 后, DOUT 端口开始转发数据,供下一个芯片提供输入数据。在转发之前, DOUT 口一直拉 低。此时芯片将不接受新的数据, 芯片 OUTR、OUTG、OUTB 三个 PWM 输出口根据接收到的 24 bit 数据, 发出相应的不同占空比的信号, 该信号周期在 4 ms。如果 DIN 端输入信号为 RESET 信号,芯片将接收到的 数据送显示,芯片将在该信号 结束后重新接受新的数据,在接受完开始的 24 bit 数据后,通过 DOUT 口转发 数 据,芯片在没有接受到 RESET 码前,OUTR、OUTG、OUTB 管脚原输出保持不 变,当接受到 804s 以上低电平 RESET 码后,芯片将刚才接收到的 24 bit PWM 数据脉宽输出到 OUTR、OUTG、OUTB 引脚上。除 DIN 外, 芯 接收上一个芯片的 DIN 数据,也就是上上一个芯片的 DOUT 数据。级联时, 片额外设计了 FDIN 输入端, 如果某一颗芯片损坏,不影响数据传输,后续芯片仍能 正常接收数据。LED 具有低电压驱动, 环保节能, 亮 度高,散射角度大,一致性好,超低功率,超长寿命等优点。将控制电路集成于LED上面, 简单,体积小,安装更加简便。

XL-2020 (6812) is an intelligent external control LED light source integrating control circuit and luminous circuit. Its appearance is the same as a 2020 LED lamp bead, and each element is a pixel. The pixel contains an intelligent digital interface data latch signal shaping and amplification drive circuit, a power supply voltage stabilizing circuit, a built-in constant current circuit, a high-precision RC oscillator, and a patented PWM technology for output drive, which effectively ensures the high consistency of the color of the light in the pixel. The chip adopts single line communication mode, and sends signals by returning to zero code. After the chip is powered on and reset, it receives the data from the DIN terminal. After receiving enough 24 bits, the DOUT port starts to forward the data for the next chip to provide input data. The DOUT port is always pulled down before forwarding. At this time, the chip will not accept new data. The chip OUTR, OUTG, and OUTB PWM output ports will send corresponding signals with different duty cycles according to the received 24 bit data. The signal cycle is 4 ms. If the input signal at the DIN end is a RESET signal, the chip will send the received data to the display, and the chip will accept new data after the end of the signal. After receiving the initial 24 bit data, the chip will forward the data through the DOUT port. Before the chip receives the RESET code, the original output of OUTR, OUTG, OUTB pins will remain unchanged. When the chip receives the low-level RESET code above 80 μ s, The chip outputs the 24 bit PWM data pulse width just received to OUTR, OUTG and OUTB pins. In addition to DIN, the chip is additionally designed with an FDIN input terminal to receive the DIN data of the previous chip, that is, the DOUT data of the previous chip. When cascading, if a chip is damaged, data transmission will not be affected, and subsequent chips can still receive data normally. LED has the advantages of low voltage drive, environmental protection and energy conservation, high brightness, large scattering angle, good consistency, ultra-low power, and ultra long life. The control circuit is integrated on the LED, which makes the circuit simpler, smaller and easier to install.



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电性参数

Electrical Characteristics

极限参数(Ta=25℃)Absolute Maximum Rating(ta=25 ℃)

电气参数 Electrical parameters	符号 Symbol	极限范围 limit range	单位 Unit
供电电压 Supply Voltage	Vin	3.5- 5.5	V
逻辑输入电压 Logic input Voltage	Vds	$-0.5 \sim \mathrm{Vdd} + 0.5$	V
输出端口耐压 Output port withstand voltage	Vi	13	V
工作温度 working temperature	Topt	-40~+85	°C
储存温度 Storage temperature	Tstg	-40~+85	°C
ESD 耐压 ESD withstand voltage	Vesd	2K	V

光电特性参数(Ta=25℃) Optical-electrical parameter(ta=25 °C)

参数名称	颜色	符号	测试条件	最小值	典型值	最大值	单位
Parameter	Colour	Symbol	Test conditions	Min	Тур	Max	Unit
N. 70	红 red			50	-	150	
光强 light intensity	绿 green	IV	V	200	-	400	mcd
ngin intensity	蓝 blue			50	-	150	
). N-l- IZ	红 red			620	-	625	
主波长 Main wavelength	绿 green	λD	IF=5mA	525	-	530	nm
5	蓝 blue			470	-	475	
ルタ /+t /a-t- 1/	红 red			-	625	-	
峰值波长 Peak wavelength	绿 green	λΡ		-	525	-	nm
Tour wavelength	蓝 blue	701		-	470	-	
半光强视角 Half light angle	-	201/2		-	120	-	Deg



电气参数: Electrical parameters (ta=25 °C):

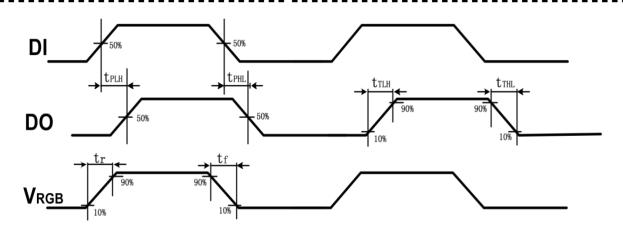
参数	符号	最小	典型	最大	单位	测试条件
Parameter	Symbol	Min	Тур.	Max	Unit	Testconditions
工作电流 Operating Current	Idd	-	0.5	-	mA	-
R/G/B 驱动电流 R/G/B drive current	ILED01	-	5	-	mA	-
DI 高电平输入 Di High level input	$ m V_{IH}$	0.5VDD	-	-	V	-
DI 低电平输入 Di Low level input	$V_{ m IL}$	-	-	0.25VDD	V	-

开关特性 : Switching characteristics (ta=-40 ~ +85 ℃):

参数 Parameter	符号 Symbo l	最小 Min	典型 Typ	最大 Max	单位 Unit	测试条件 Test conditions
数据传输速度 Data transfer speed	fDATA	-	800	-	kHz	-
R/G/B 口的 PWM 频率 PWM FREQUENCY OF R/G/B port	fPWM	-	1.5	-	kHz	-
数据转发传输延迟	tPLH	-	0.21	-	us	DI DO 信号延时,DO 端
Data forward transmission delay	tPHL	-	0.21	-	us	口对地负载电容 30pF
DO 电平转换时间	tTLH	-	0.018	-	us	DO 地口对此点类由党 20 E
Do level transition time	tTHL	-	0.018	-	us	DO 端口对地负载电容 30pF
RGB 口电平转换时间(注 1)	tr	-	0.15	-	us	I _{LED} =5mA,RGB 端口串接
RGB Port Level Conversion Time (Note 1)	tf	-	0.40	-	us	200Ω电阻至 VDD,对地负载 电容 30pF

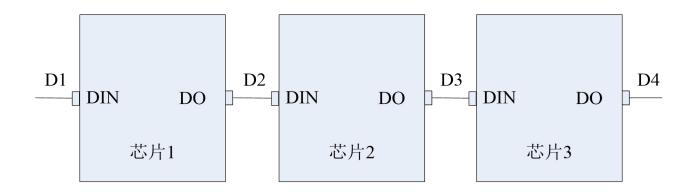
注 1/Note 1: 为了减少 RGB 端口的开关对电源电压的冲击,tr/ff 比较缓慢,不影响点亮/ To reduce the impact of RGB port switches on the supply voltage, TR/TF is slow and does not affect the lighting





注 2/Note 2: 交流参数示意图/Schematic Diagram of the AC parameters

芯片级联方法: Chip cascade method:



功能说明/Description of functions

2020 内封 IC 灯珠采用归零码的方式发送信号。芯片在上电复位以后,接收 DIN 端打来的数据,接收够 24bit 后,DO 端口开始转发数据,供下一个芯片提供输入数据。在转发之前,DO 口一直拉低。此时灯珠将不接收新的数据,内置 RGB 芯片根据接收到的 24bit 数据后产生的不同占空比信号,展现不同亮度。如果 DIN 端输入信号为 RESET 信号,芯片将接收到的数据送显示,芯片将在该信号结束后重新接收新的数据,在接收完开始的 24bit 数据后,通过 DO 口转发数据,灯珠在没有接收到 RESET 码前,RGB 亮度保持不变,当接收到 80us 以上低电平 RESET 码后,灯珠内部 RGB 芯片将根据刚才接收到的 24bit 数据后产生的不同占空比信号,展现不同亮度。

The 2020 internal sealed IC lamp beads send signals by means of returning to zero code. After the reset, the chip receives the data from Din. After receiving 24 bits, the DO begins to transmit the data for the next chip to provide the input data. The DO was pulled down until it was retweeted. At this point will not receive new data, BUILT-IN RGB chip according to the received 24 bit data generated by the duty cycle signal, display different brightness. If the DIN input signal is a RESET signal, the chip will send the received data to display, the chip will re-receive the new data after the end of the signal, after receiving the initial 24 bit data, the data will be transmitted through the DO port, before receiving the Reset Code, the RGB brightness remains the same. After receiving the low level RESET code above 80us, the RGB chip inside the lamp will display different brightness according to the different duty cycle signal produced after receiving the 24bit data just now.



数据传输方式: Date transmission mode

	<u> </u>	数据刷新周期一	·	RST >100us	<u> </u>	数据刷新周期一	- - 	
D1	第一个24bit	第二个24bit	第三个24bit		第一个24bit	第二个24bit	第三个24bit	
D2		第二个24bit	第三个24bit			第二个24bit	第三个24bit	
		-				-		
D3			第三个24bit				第三个24bit	
D4								
								_

注: 其中 D1 为 MCU 端发送的数据, D2、D3、D4 为级联电路自动整形转发的数据 Note: D1 refers to the data sent by MCU, and D2, D3 and D4 refer to the data automatically shaped and forwarded by cascade circuit

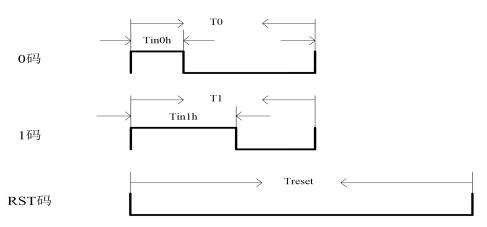
24bit 数据结构: 24bit data structure:

G							G																
7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0

注: 高位先发, 按照 GRB 的顺序发送数据

Note: high order first send, send data in the order of GrB

数据时序波形图:Time sequence waveform:



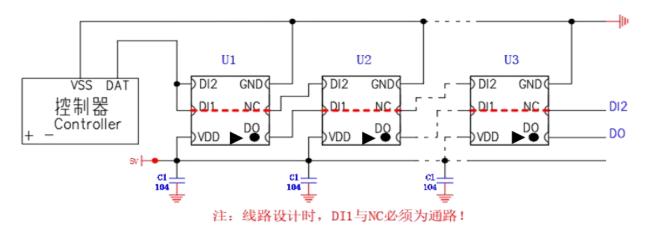


数据传输定义: Signal transmission definition

参数	符号	最小值	典型	最大值	单位	
Parameter	Symbol	Min	Тур	Max	Unit	
输入 0 码高电平时间	TinOh		0. 25	0, 47		
Input 0 code high level time	TTHOH		0.25	0.47	us	
输入1码高电平时间	Tin1h	0, 58	0, 85	1	110	
Input 1 code high level time	Tin1h	0. 56	0.85	1	us	
输入 0 码低电平时间	TOL		1			
Input 0 code low level time	TUL	_	1		us	
输入1码低电平时间	Т11		0.4			
Input 1 code low level time	T1L	_	0. 4	_	us	
0 码/1 码周期	TO /T1	1 0	1 05			
0 code /1 code cycle	T0/T1	1.2	1. 25	_	us	
RESET 码低电平时间		90			-1-	
Reset code low level time	reset	80	_	_	us	

注:控制器发送数据 "O"码高电平时间必须小于 O.47us; 数据 "1"码高电平时间必须大于 O.58u Note: Controller must send data "0" Code High Level Time is less than 0.47 US; data "1" Code high level time is more than 0.58 us.

应用线路图: Application circuit diagram:



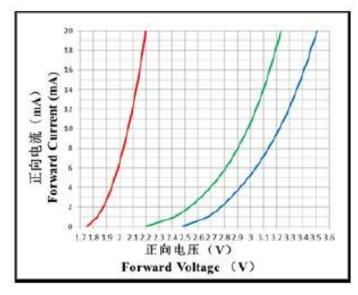
产品应用中驱控灯珠级联数量及控制器参数配置、驱动电源品质均有较大差异,故请在批量使用产品前,客户方务必自行验证产品兼容性,我司不承诺满足客户所有应用需求.

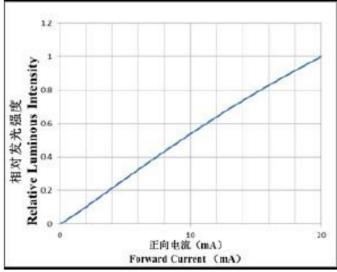
In the application of the product, there are great differences in the cascade number of drive control light beads, the parameter configuration of the controller and the quality of the drive power supply. Therefore, before using the product in batch, the customer must verify the compatibility of the product by himself. Our company does not promise to meet all the application needs of the customer

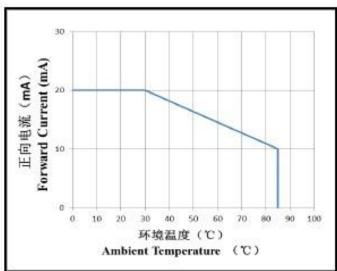


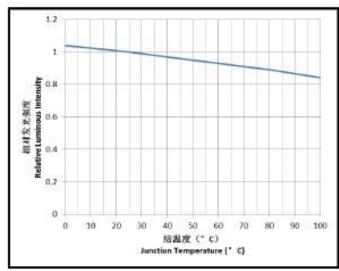
典型特性曲线

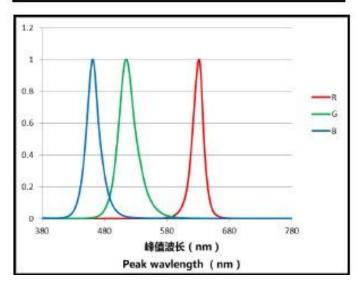
Typical Characteristics Curves

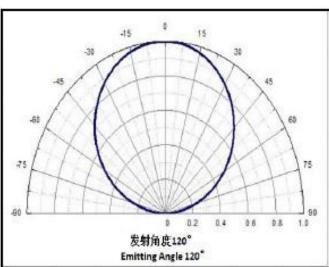














可靠性试验

Reliability Test Items And Conditions

*可靠性实验项目 Reliability Test Project

描述	项目	测试标准	测试条件	测试时间	数量	失效数量
Description	ltem	Test criterion	criterion Test condition		Qty	Failqty
寿命测试 Life test	常温寿命测试 Life test(room temperature)	JIS7021:B4	Ta=25°C±5°C,IF=5mA	1000Hrs	22	0
	高温存储 High temperature store	JIS7021:B10 MIL-STD-202:210A MIL-STD-750:2031	Ta=85°C±5°C	1000Hrs	22	0
	低温存储 Low temperature store	JIS7021:B12	Ta=-35°C±5°C	1000Hrs	22	0
环境测试	高温高湿测试 High temperature/ humidity test	JIS7021:B11 MIL-STD-202:103D	Ta=85°C±5°C RH=85%	1000Hrs	22	0
Ambience test	冷热中击测试 Cold / Heat strike test	JIS7021::B4 MIL-STD-202:107D MIL-STD-750:1026	30min -10°C±5°C ←→100°C± 5°C 5min 5min	100Cydes	22	0
	冷热循环测试 Cold and heat cycle test	JIS7021:A3 MIL-STD-202:107D MIL-STD-705:105E	5min 5min 5min -35°C~25°C~85°C~ -35°C 30min 5min 30min 5min	10Cycles	22	0

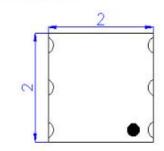
*判断标准 Judging criterion:

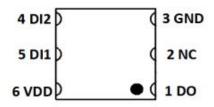
项目	符号	实验条件 Experiment	判断标准 Criteria			
ltem	Symbol	condition	Min.	Max.		
Forward Voltage 正向电压	VF	IF=5mA		Initial Datex1.1		
Reverse Current 反向电流	IR	VR=5V		1 µ A		
Luminous Intensity 发光强度	IV	IF=5mA	Initial Datex0.7			

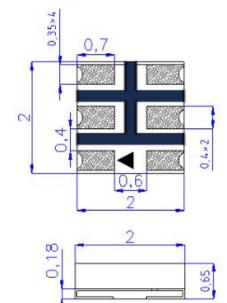


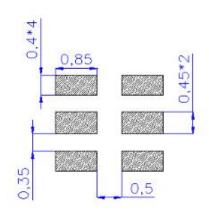
外形尺寸

Outline Dimension









建议焊盘尺寸: Recommended Soldering Pattern

备注: 1. 以上尺寸单位均为 mm

Remarks: All dimensions are in millimeters.

2. 未特别标注公差的尺寸公差均为±0. 25mm

引脚电路图及引脚功能:

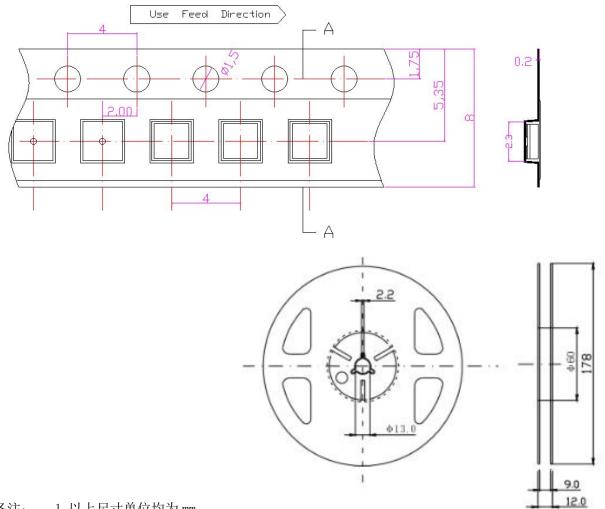
引脚序号	符号	力能描述 功能描述
Pin No	Symbol	Function description
1	DO	显示数据级联输出(800K)
1	DO	Display data cascade output (800K)
2	NC	-
2	CND	信号地及电源地
3	GND	Signal ground and power supply ground
4	DI2	辅助显示数据输入
4	D12	Auxiliary display data input
5	DI1	主显示数据输入
3	DII	Main display data input
6	VDD	内部 IC 电源正及 RGB 正极
6	עטעי	INTERNAL IC power supply and RGB positive pole



包装(1)

Packaging (1)

载带与圆盘尺寸 Belt and disk dimensions



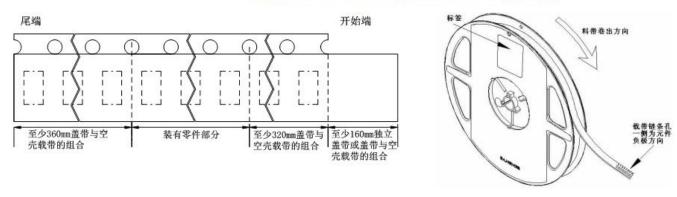
1. 以上尺寸单位均为 mm 备注:

Remarks: All dimensions are in millimeters.

2. 未特别标注公差的尺寸公差均为±0. 25mm

Tolerance is ± 0.25 mm unless otherwise noted

圆盘及载带卷出方向及空穴规格 Disk and carrier belt direction of roll and hole dimensions

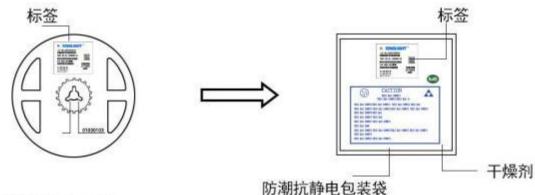




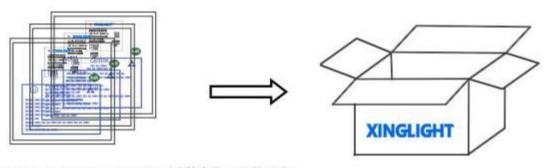
包装(2)

Packaging (2)

◇ 防潮抗静电包装 Moisture Proof and Anti-Electrostatic Foil Bag



◇ 外包装箱 Cardboard Box



Capactiy 5 or 10 reels per box (内箱容量: 50或100卷)

◇ 标签说明: Label Explantion

LOT NO: 批次信息

PART NO: 产品型号

BIN CODE: 产品名称

WL: 波长范围

IV: 光强范围

VF: 电压范围





焊接指导(1)

Guideline for Soldering (1)

1. 使用烙铁人手焊接

Hand Soldering

只建议在修理和重工的情况下使用手工焊接;推荐使用功率低于 30W 的烙铁,焊接时烙铁的温度必须保 持在 300℃以下,且每个电极只能进行一次焊接,每次焊接的持续时间不得超过 3 秒。

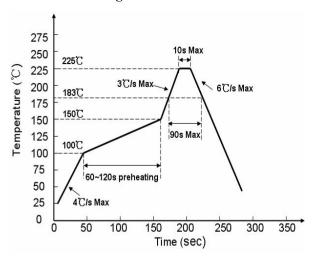
人手焊接过程中的不慎操作易引起 LED 产品的损坏,应当小心谨慎。

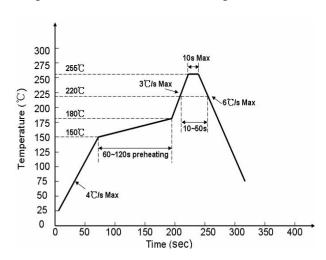
Manual welding is recommended only for repair and heavy industry situations. A soldering iron of less than $30\,\mathrm{W}$ is recommended to be used in Hand Soldering. Please keep the temperature of the soldering iron under $300\,\mathrm{C}$ while soldering. Each terminal of the LED is to go for less than 3 second and for one time only.

Be careful because the damage of the product is often started at the time of the hand soldering.

2. 回流焊接: 推荐使用以下无铅回流焊接温度图进行。

Reflow Soldering: Use the conditions shown in the under Figure of Pb -Free Reflow Soldering.





有铅制程 Lead process

无铅制程 lead free

回流焊接最多只能进行两次。

Reflow soldering should not be done more than two times.

在回流焊接升温过程中,请不要对 LED 施加任何压力。

Stress on the LEDs should be avoided during heating in soldering process.

在焊接完成后,待产品温度下降到室温之后,再进行其他处理。

After soldering, do not deal with the product before its temperature drop down to room temperature.



焊接指导(2)

Guideline for Soldering (2)

3. 清洗:

Cleaning

在焊接后推荐使用酒精进行清洗,在温度不高于 30℃的条件下持续 3 分钟, 不高于 50℃的条件下持续 30 秒。

使用其他类似溶剂清洗前,请先确认使用的溶剂不会对 LED 的封装和环氧树脂部分造成损伤。超声波清洗也是有效的方法,一般最大功率不应超过 300W,否则可能对 LED 造成损伤。请根据 具体的 情况预先测试清洗条件是否会对 LED 造成损伤。

It is recommended that alcohol be used as a solvent for cleaning after soldering. Cleaning is to go under 30°C for 3 minutes or 50°C for 30 seconds. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not.

Ultrasonic cleaning is also an effective way for cleaning. But the influence of Ultrasonic cleaning on LED depends on factors such as ultrasonic power. Generally, the ultrasonic power should not be higher than 300W. Before cleaning, a pretest should be done to confirm whether any damage to LEDs will occur.

- * **注意:** 此一般指导原则并不适用于所有 PCB 设计和焊接设备的配置。具体工艺受到诸多因素的影响, 请根据特定的 PCB 设计和焊接设备来确定焊接方案。
- * Note: This general guideline may not apply to all PCB designs and configurations of all soldering equipment. The technics in practise is influenced by many factors, it should be specialized base on the PCB designs and configurations of the soldering equipment..



使用注意事项(1)

Precautions (1)

1. 贮存:

Storage

• 本产品使用密封防潮抗静电袋包装,并附有干燥剂,未开封的产品有一年的保存时间。

Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to a minimum.

• 开封前,产品须存放在温度不高于 30℃,湿度不高于 60%RH 的环境中。

Before opening the package, the product should be kept at 30°C or less and umidity less than 60% RH, and be used within a year.

• 开封后,产品须存放在温度不高于 30℃,湿度不高于 40%RH 的环境中,且应该在 72 小时(3 天) 内使 用完。建议工作环境为温度不高于 30℃,湿度不高于 60%RH。

After opening the package, the product should be stored at 30°C or less and humidity less than 40%RH, and be soldered within 72 hours (3 days). It is recommended that the product be operated at the workshop condition of 30°C or less and humidity less than 60%RH.

• 对于尚未焊接的 LED ,如果吸湿剂或包装失效,或者产品没有符合以上有效存储条件,烘焙可以起到一定的性能恢复效果。烘焙条件: 60±5) ℃,持续24 小时。

If the moisture absorbent material has fade away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition: $(60\pm5)^{\circ}$ °C for 24 hours.

2. 静电:

Static Electricity

静电和电涌会导致产品特性发生改变,例如正向电压降低等,如果情况严重甚至会损毁产品。所以在使用时必须采取有效的 防静电措施。所有相关的设备和机器都应该正确接地,同时必须采取其他防止静电和电涌的措施。使用防静电 手环,防静电垫子,防静电工作服、工作鞋、手套,防静电容器,都是有效的防止静电和电涌的措施。

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristic such as the forward voltage becomes lower, or the LEDs do not light at the low current. even not light.

All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.

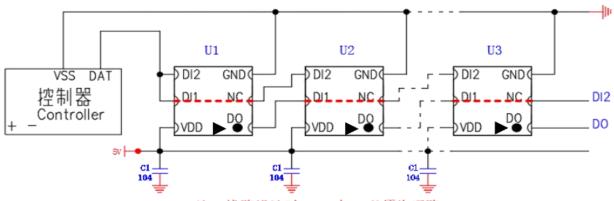


使用注意事项(2)

Precautions (2)

3. 设计建议:

Design Consideration



注:线路设计时,DI1与NC必须为通路!

在实际应用电路中,为防止产品在测试时带电插拔产生的瞬间高压损伤 IC 内部电源及 信号输入输出脚,应在信号输入及输出端串接保护电阻。此外,为了使各 IC 芯片间更 稳定工作,各灯珠间的退偶电容则必不可少;

- 1. 产品两端所并的退偶电容一般不建议省略;
- 2. 产品的信号输入及输出端必需串接保护电阻 R1/R2, 因线材及传输距离不同, 在信号线两端串接的保护电阻会略有不同; R1/R2 的大小取决于级联灯珠的数量,级联数量越多,则 R1/R2 越小,灯珠间传输距离长,一般建议在 20-2K Ω之间取值,建议通常建议取值 在 500 欧左右;以实际使用情况定; R2 可接地或悬空。

In practical application circuits, To prevent instantaneous high voltage generated by live plugging during product testing Damage to IC internal power supply and signal input/output pins Protective resistors should be connected in series at the signal input and output terminals. In addition, in order to ensure more stable operation between IC chips The decoupling capacitance between each lamp bead is essential:

- 1. It is generally not recommended to omit the decoupling capacitors connected at both ends of the pr...;
- 2. The signal input and output terminals of the product must be connected in series with protective r...; Due to differences in wire material and transmission distance; The size of r1/r2 depends on the number of cascaded lamp beads , The more cascades, the smaller r1/r2; Long transmission distance between lamp beads , Generally recommended between 20-2k ω Value between, The recommended value is usually around 500 euros; Based on actual usage; R2 can be grounded suspended.



使用注意事项(3)

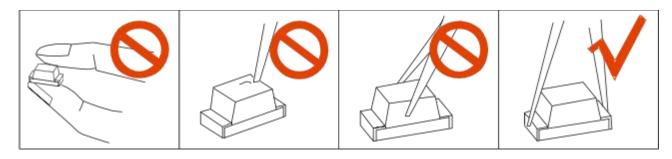
Precautions (3)

4. 其他事项:

Others

直接用手拿取产品不但会污染封装树脂表面,也可能由于静电等因素导致产品性能的改变。过度的压力也可能直接影响封装内部的管芯和金线,因此请勿对产品施加过度压力,特别当产品处于高温状态下,例如在回流焊接过程中。

When handling the product, touching the encapsulant with bare hands will not only contaminate its surface, but also affect on its optical characteristics. Excessive force to the encapsulant might result in catastrophic failure of the LEDs due to die breakage or wire deformation. For this reason, please do not put excessive stress on LEDs, especially when the LEDs are heated such as during Reflow Soldering.



LED 的环氧树脂封装部分相当脆弱,请勿用坚硬、尖锐的物体刮、擦封装树脂部分。在用镊子夹取的时候也应当小心注意。

The epoxy resin of encapsulant is fragile, so please avoid scratch or friction over the epoxy resin surface. While handling the product with tweezers, do not hold by the epoxy resin, be careful.

5. 眼睛保护忠告:

Safety Advice For Human Eyes

LED 发光时,请勿直视发光光源,特别是对于一些光强较高的 LED ,强光可能伤害你的眼睛。

Viewing direct to the light emitting center of the LEDs, especially those of great Luminous Intensity, will cause great hazard to human eyes. Please be careful.